

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

10/0

In re the PATENT application of

T.L. Ritzdorf et al

Examiner: Leader, William T.

Group Art Unit: 1741

Serial No.:09/880,715

Filed: June 12, 2001

For:

Method for Filling Recessed Micro-Structures with Metallization in the

Production of a Microelectronic Device

## <u>AMENDMENT</u>

**Box: Amendment** 

Commissioner for Patents Washington, D.C. 20231

Sir:

Please amend the subject patent application as follows:

In the Claims:

Cancel claims 32-53 without prejudice to their continued prosecution.

## REMARKS

Claims 32-53 have been canceled. Claims 54-59 remain in the subject application and have not been changed from their immediately prior version. Claims 54-59 were added to the subject application in a Second Preliminary Amendment dated October 15, 2002 for the purpose of provoking an interference with U.S. Patent No. 6,074,544.

It is believed that the subject application is now in condition for immediate action